DATA SHEET

BLW50F
HF/VHF power transistor

Product specification

August 1986

Philips
Semiconductors

PHILIPS

HF/VHF power transistor BLW50F

DESCRIPTION

N-P-N silicon planar epitaxial transistor primarily intended for use in class-A, AB and B operated, industrial and military transmitters in the h.f. and v.h.f. band. Resistance stabilization provides protection against device damage at severe load mismatch conditions. Matched h_{FE} groups are available on request.

It has a 3/8" flange envelope with a ceramic cap. All leads are isolated from the flange.

QUICK REFERENCE DATA

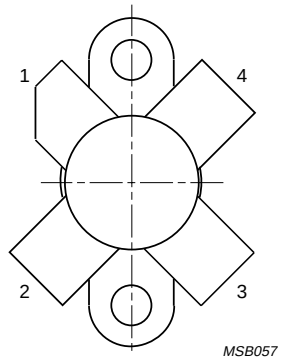
R.F. performance

MODE OF OPERATION	V_{CE} V	f MHz	P_L W	G_p dB	η_{dt} %	I_C A	$I_{C(ZS)}$ mA	d_3 dB	T_h °C
s.s.b. (class-A)	45	1,6 - 28	0 - 16 (P.E.P.)	> 19,5	–	1,2	–	< –40	70
s.s.b. (class-AB)	50	1,6 - 28	10 - 65 (P.E.P.)	typ. 18	typ. 45(1)	1,45	50	typ. –30	25

Note

1. At 65W P.E.P.

PIN CONFIGURATION



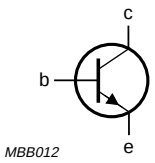


Fig.1 Simplified outline and symbol.

PINNING - SOT123

PIN	DESCRIPTION
1	collector
2	emitter
3	base
4	emitter

PRODUCT SAFETY This device incorporates beryllium oxide, the dust of which is toxic. The device is entirely safe provided that the BeO disc is not damaged.

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

Collector-emitter voltage (V_{BE} = 0)				
peak value	V_{CESM}	max.	110	V
Collector-emitter voltage (open base)	V_{CEO}	max.	55	V
Emitter-base voltage (open collector)	V_{EBO}	max.	4	V
Collector current (average)	$I_{C(AV)}$	max.	2,5	A
Collector current (peak value); f > 1 MHz	I_{CM}	max.	7,5	A
D.C. and r.f. (f > 1 MHz) power dissipation; T_{mb} = 25 °C	P_{tot}; P_{rf}	max.	94	W
Storage temperature	T_{stg}		−65 to + 150	°C
Operating junction temperature	T_j	max.	200	°C

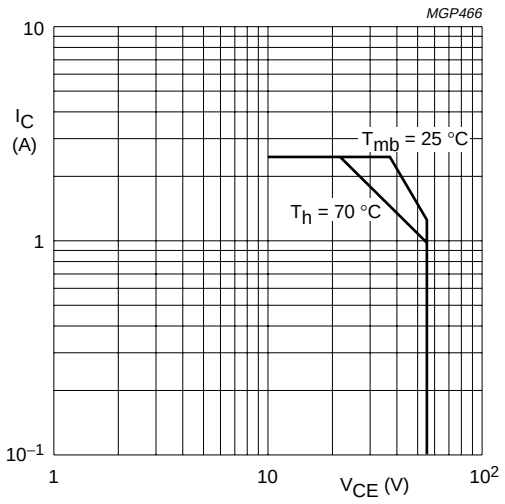
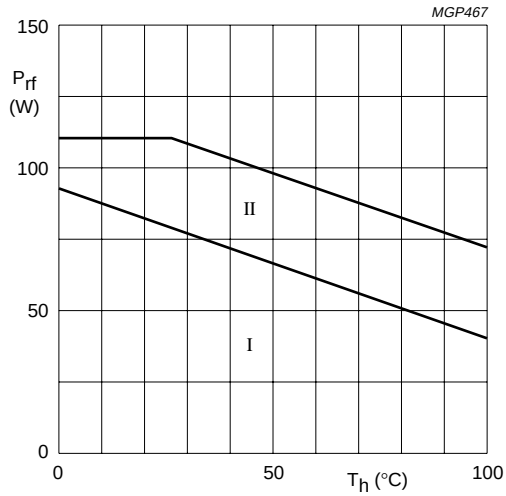


Fig.2 D.C. SOAR.



I Continuous d.c. and r.f. operation
II Short-time operation during mismatch

Fig.3 Power derating curves vs. temperature.

THERMAL RESISTANCE

(dissipation = 54 W; T_{mb} = 86 °C, i.e. T_h = 70 °C)

From junction to mounting base (d.c. and r.f. dissipation)	$R_{th\ j\text{-}mb}$	=	2,1	K/W
From mounting base to heatsink	$R_{th\ mb\text{-}h}$	=	0,3	K/W

CHARACTERISTICS

T_j = 25 °C

Collector-emitter breakdown voltage				
V_{BE} = 0; I_C = 25 mA	$V_{(BR)\ CES}$	>	110	V
Collector-emitter breakdown voltage				
open base; I_C = 100 mA	$V_{(BR)\ CEO}$	>	55	V
Emitter-base breakdown voltage				
open collector; I_E = 10 mA	$V_{(BR)EBO}$	>	4	V
Collector cut-off current				
V_{BE} = 0; V_{CE} = 55 V	I_{CES}	<	10	mA
Second breakdown energy; L = 25 mH; f = 50 Hz				
open base	E_{SBO}	>	8	mJ
R_{BE} = 10 Ω	E_{SBR}	>	8	mJ
D.C. current gain(1)				
I_C = 1,2 A; V_{CE} = 5 V	h_{FE}	typ. 15 to 100	25	
D.C. current gain ratio of matched devices(1)				
I_C = 1,2 A; V_{CE} = 5 V	h_{FE1}/h_{FE2}	<	1,2	
Collector-emitter saturation voltage(1)				
I_C = 3,0 A; I_B = 0,6 A	V_{CEsat}	typ.	1,2	V
Transition frequency at f = 100 MHz(1)				
$-I_E$ = 1,2 A; V_{CB} = 45 V	f_T	typ.	490	MHz
$-I_E$ = 4,0 A; V_{CB} = 45 V	f_T	typ.	540	MHz
Collector capacitance at f = 1 MHz				
$I_E = I_e$ = 0; V_{CB} = 45 V	C_c	typ.	53	pF
Feedback capacitance at f = 1 MHz				
I_C = 50 mA; V_{CE} = 45 V	C_{re}	typ.	35	pF
Collector-flange capacitance	C_{cf}	typ.	2	pF

Note

1. Measured under pulse conditions: $t_p \leq 200$ μs; $\delta \leq 0{,}02$.

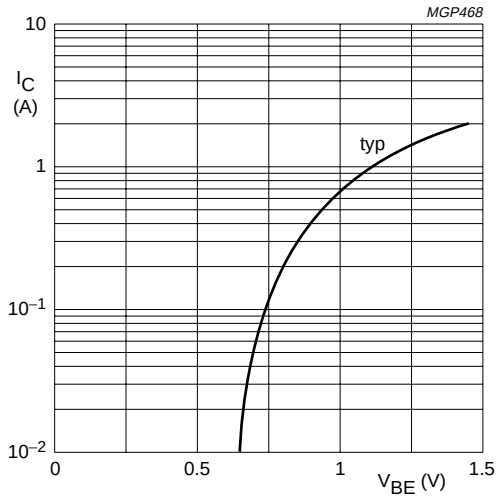


Fig.4 V_{CE} = 40 V; T_{mb} = 25 °C.

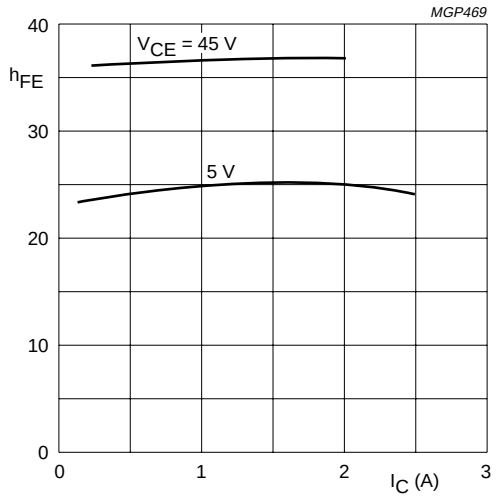


Fig.5 Typical values; T_j = 25 °C.

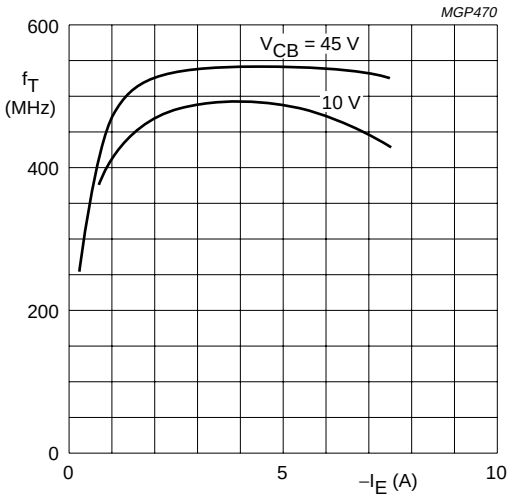


Fig.6 Typical values; f = 100 MHz; T_j = 25 °C.

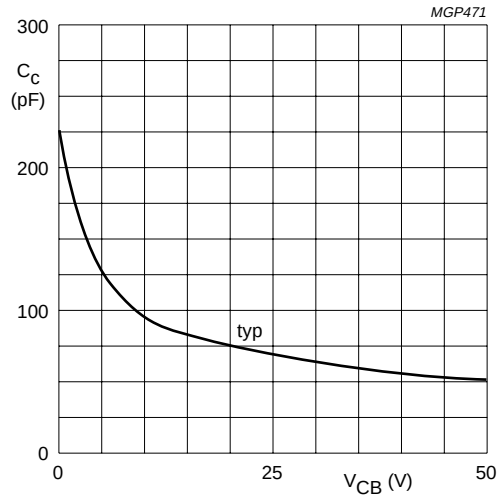


Fig.7 $I_E = I_e$ = 0; f = 1 MHz; T_j = 25 °C.

APPLICATION INFORMATION

R.F. performance in s.s.b. class-A operation (linear power amplifier)
V_{CE} = 45 V; f_1 = 28,000 MHz; f_2 = 28,001 MHz

OUTPUT POWER W	G_p dB	I_C A	d_3(1) dB	d_5(1) dB	T_h °C
> 16 (P.E.P.)	> 19,5	1,2	–40	< –40	70
typ. 17 (P.E.P.)	typ. 20,5	1,2	–40	< –40	70

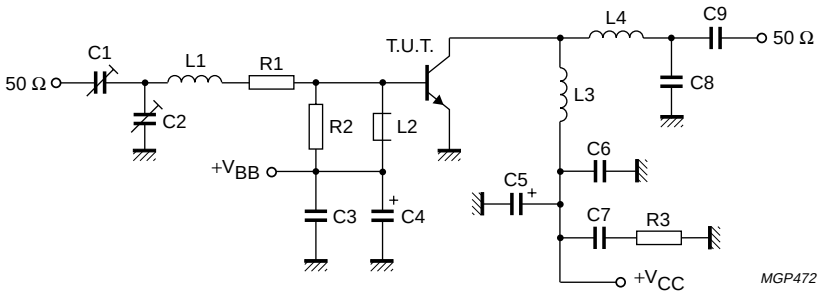


Fig.8 Test circuit; s.s.b. class-A.

List of components in Fig.8:

C1 = C2 = 10 to 780 pF film dielectric trimmer
C3 = 22 nF ceramic capacitor (63 V)
C4 = 4,7 μF/16 V electrolytic capacitor
C5 = 1 μF/75 V solid tantalum capacitor
C6 = C7 = 47 nF polyester capacitor (100 V)
C8 = 68 pF ceramic capacitor (500 V)
C9 = 3,9 nF ceramic capacitor
L1 = 3 turns closely wound enamelled Cu wire (1,0 mm); int. dia 9,0 mm; leads 2 × 5 mm
L2 = Ferroxcube wide-band h.f. choke, grade 3B (cat. no. 4312 020 36640)
L3 = 1,05 μH; 15 turns enamelled Cu wire (1,0 mm); int. dia. 10 mm; length 17,4 mm; leads 2 × 5 mm
L4 = 162 nH; 6 turns enamelled Cu wire (1,0 mm); int. dia. 7,0 mm; length 11,6 mm; leads 2 × 5 mm
R1 = 1,6 Ω; parallel connection of 3 × 4,7 Ω carbon resistors (± 5%; 0,125 W)
R2 = 47 Ω carbon resistor (± 5%; 0,25 W)
R3 = 4,7 Ω carbon resistor (± 5%; 0,25 W)

Note

1. Stated intermodulation distortion figures are referred to the according level of either of the equal amplified tones. Relative to the according peak envelope powers these figures should be increased by 6 dB.

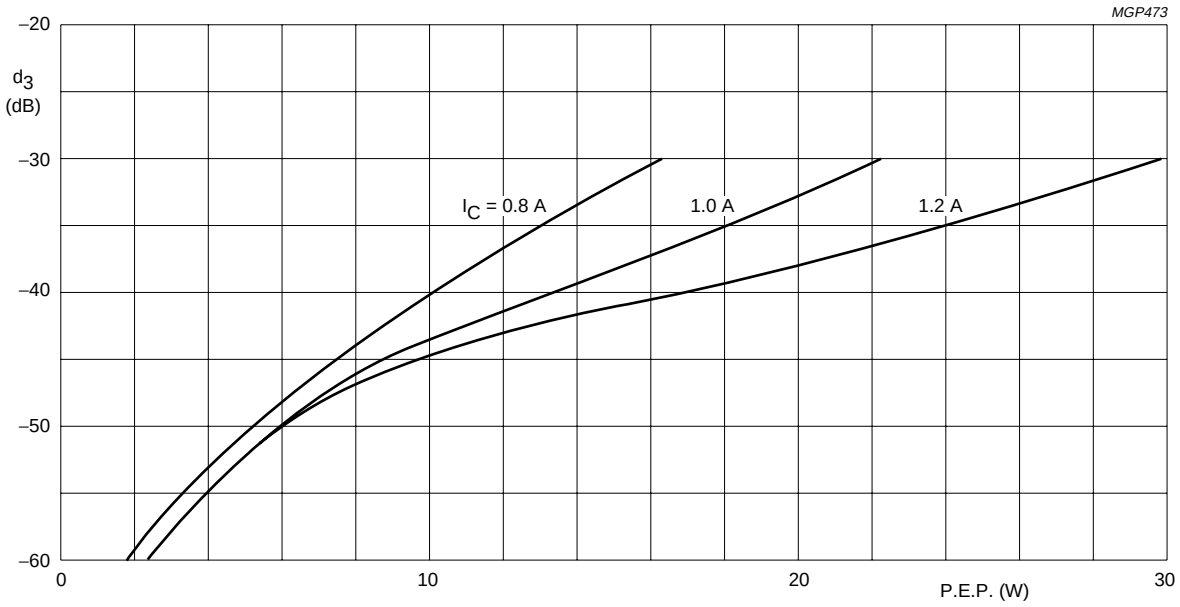


Fig.9 Intermodulation distortion (see note on previous page) as a function of output power. Typical values; V_{CE} = 45 V; f_1 = 28,000 MHz; f_2 = 28,001 MHz; T_h = 70 °C.

R.F. performance in s.s.b. class-AB operation (linear power amplifier)
V_{CE} = 50 V; f_1 = 28,000 MHz; f_2 = 28,001 MHz

OUTPUT POWER	G_p	η_{dt}(%)	I_C (A)	d_3[1]	d_5[1]	$I_{C(ZS)}$	T_h
W	dB	AT 65 W P.E.P.		dB	dB	mA	°C
10 to 65 (P.E.P.)	typ. 18	typ. 45	typ. 1,45	typ. –30	< –30	50	25

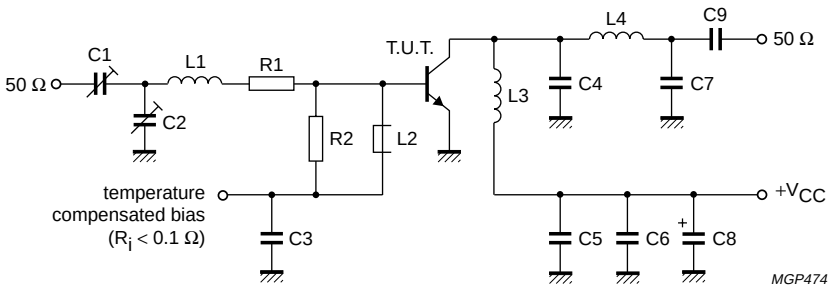


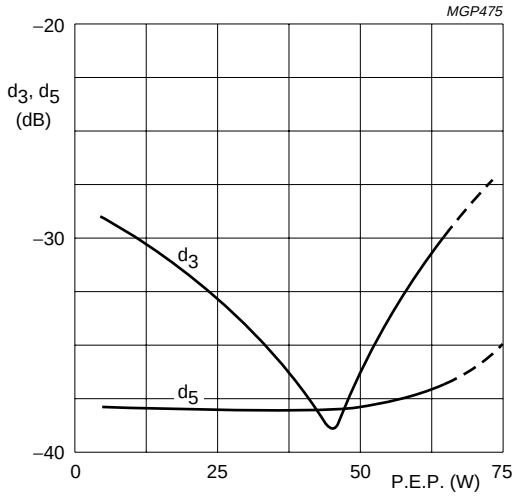
Fig.10 Test circuit; s.s.b. class-AB.

List of components:

C1 = C2 = 10 to 780 pF film dielectric trimmer
C3 = C5 = C6 = 220 nF polyester capacitor
C4 = 120 pF ceramic capacitor (500 V)
C7 = 150 pF ceramic capacitor (500 V)
C8 = 47μF/63 V electrolytic capacitor
C9 = 3,9 nF ceramic capacitor
L1 = 4 turns closely wound enamelled Cu wire (1,6 mm); int. dia 7,0 mm; leads 2 × 5 mm
L2 = Ferroxcube wide-band h.f. choke, grade 3B (cat.no. 4312 020 36640)
L3 = 9 turns enamelled Cu wire (1,0 mm); int. dia. 10 mm; length 14,5 mm; leads 2 × 5 mm
L4 = 6 turns enamelled Cu wire (1,0 mm); int. dia. 6,5 mm; length 11,0 mm; leads 2 × 5 mm
R1 = 2,4 Ω; parallel connection of 2 × 4,7 Ω carbon resistors
R2 = 39 Ω carbon resistor

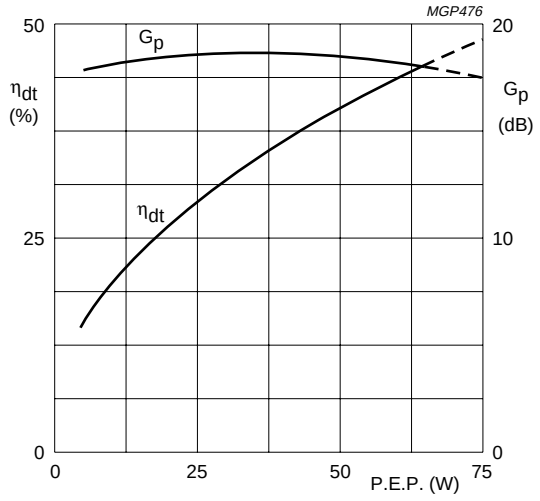
Note

1. Stated intermodulation distortion figures are referred to the according level of either of the equal amplified tones. Relative to the according peak envelope powers these figures should be increased by 6 dB.



V_{CE} = 50 V; $I_{C(ZS)}$ = 50 mA; f_1 = 28,000 MHz; f_2 = 28,001 MHz; T_h = 25 °C; typical values.

Fig.11 Intermodulation distortion as a function of output power(1).



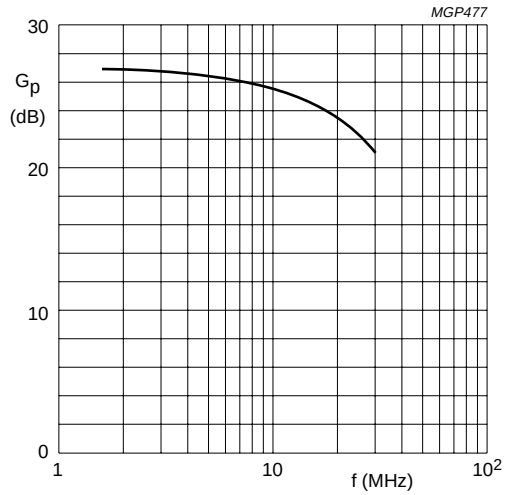
V_{CE} = 50 V; $I_{C(ZS)}$ = 50 mA; f_1 = 28,000 MHz; f_2 = 28,001 MHz; T_h = 25 °C; typical values.

Fig.12 Double-tone efficiency and power gain as a function of output power.

Ruggedness in s.s.b. operation

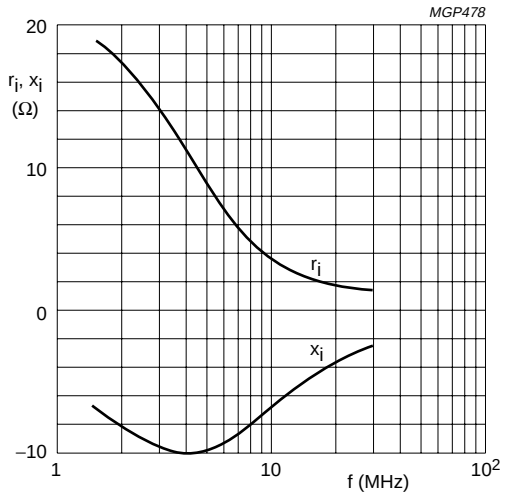
The BLW50F is capable of withstanding full load mismatch (VSWR = 50 through all phases) up to 45 W (P.E.P.) under the following conditions:

V_{CE} = 50 V; f_1 = 28,000 MHz; f_2 = 28,001 MHz; T_h = 70 °C; $R_{th\ mb\text{-}h}$ = 0,3 K/W.



V_{CE} = 50 V; $I_{C(ZS)}$ = 50 mA; P_L = 60 W;
T_h = 25 °C; Z_L = 16 Ω.

Fig.13 Power gain as a function of frequency.



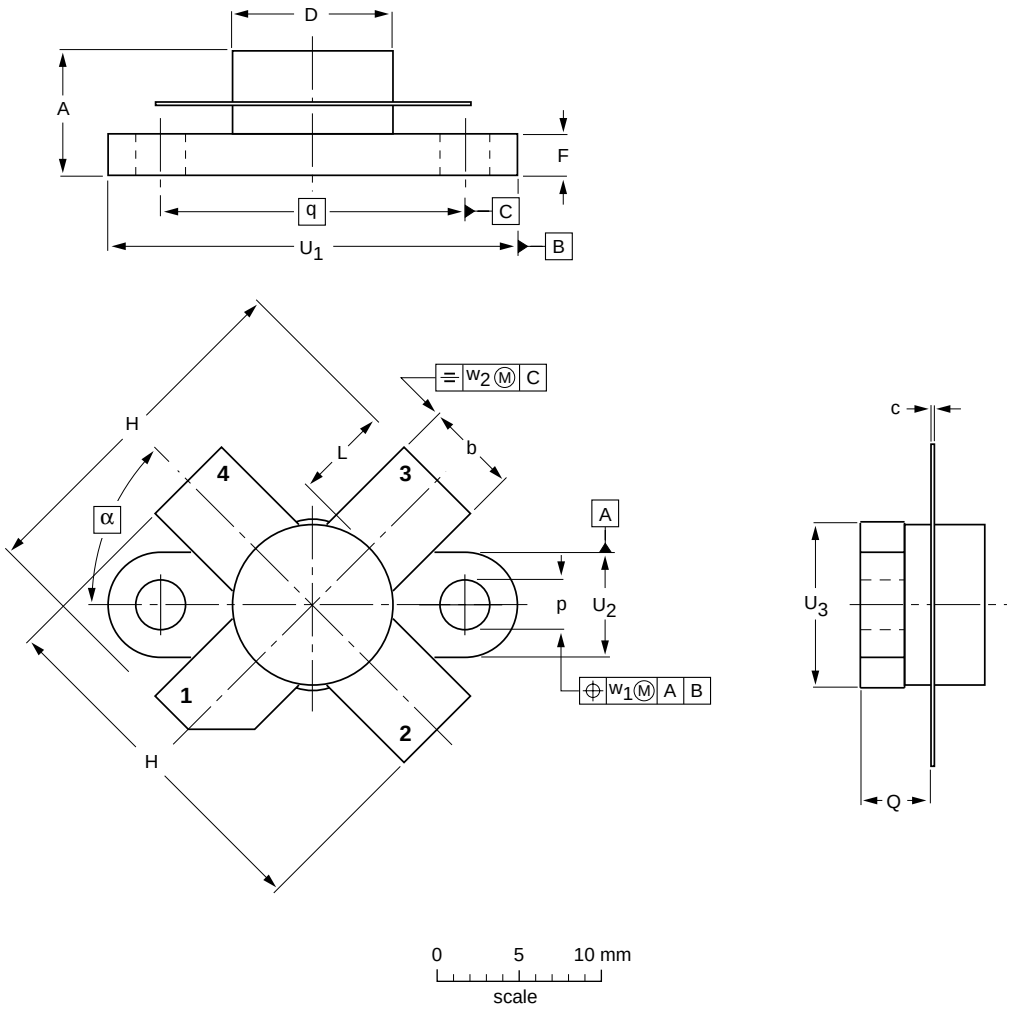
V_{CE} = 50 V; $I_{C(ZS)}$ = 50 mA; P_L = 60 W;
T_h = 25 °C; Z_L = 16 Ω.

Fig.14 Input impedance (series components) as a function of frequency.

Figs 13 and 14 are typical curves and hold for an unneutralized amplifier in s.s.b. class-AB operation.

PACKAGE OUTLINE

Flanged ceramic package; 2 mounting holes; 4 leads **SOT123A**



DIMENSIONS (millimetre dimensions are derived from the original inch dimensions)

UNIT	A	b	c	D	D_1	F	H	L	p	Q	q	U_1	U_2	U_3	w_1	w_2	α
mm	7.47 6.37	5.82 5.56	0.18 0.10	9.73 9.47	9.63 9.42	2.72 2.31	20.71 19.93	5.61 5.16	3.33 3.04	4.63 4.11	18.42	25.15 24.38	6.61 6.09	9.78 9.39	0.51	1.02	45°
inches	0.294 0.251	0.229 0.219	0.007 0.004	0.383 0.373	0.397 0.371	0.107 0.091	0.815 0.785	0.221 0.203	0.131 0.120	0.182 0.162	0.725	0.99 0.96	0.26 0.24	0.385 0.370	0.02	0.04	

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT123A						97-06-28

DEFINITIONS

Data Sheet Status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	

LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.

SUNSTAR 商斯达实业集团是集研发、生产、工程、销售、代理经销 、技术咨询、信息服务等为一体的高科技企业，是专业高科技电子产品生产厂家，是具有 10 多年历史的专业电子元器件供应商，是中国最早和最大的仓储式连锁规模经营大型综合电子零部件代理分销商之一,是一家专业代理和分銷世界各大品牌 IC 芯片和電子元器件的连锁经营綜合性国际公司，专业经营进口、国产名厂名牌电子元件，型号、种类齐全。在香港、北京、深圳、上海、西安、成都等全国主要电子市场设有直属分公司和产品展示展销窗口门市部专卖店及代理分销商,已在全国范围内建成强大统一的供货和代理分销网络。 我们专业代理经销、开发生产电子元器件、集成电路、传感器、微波光电元器件、工控机/DOC/DOM 电子盘、专用电路、单片机开发、MCU/DSP/ARM/FPGA 软件硬件、二极管、三极管、模块等，是您可靠的一站式现货配套供应商、方案提供商、部件功能模块开发配套商。商斯达实业公司拥有庞大的资料库，有数位毕业于著名高校——有中国电子工业摇篮之称的西安电子科技大学（西军电）并长期从事国防尖端科技研究的高级工程师为您精挑细选、量身订做各种高科技电子元器件，并解决各种技术问题。

微波光电部专业代理经销高频、微波、光纤、光电元器件、组件、部件、模块、整机；电磁兼容元器件、材料、设备；微波 CAD、EDA 软件、开发测试仿真工具；微波、光纤仪器仪表。欢迎国外高科技微波、光纤厂商将优秀产品介绍到中国、共同开拓市场。长期大量现货专业批发高频、微波、卫星、光纤、电视、CATV 器件： 晶振、VCO、连接器、PIN 开关、变容二极管、开关二极管、低噪晶体管、功率电阻及电容、放大器、功率管、MMIC、混频器、耦合器、功分器、振荡器、合成器、衰减器、滤波器、隔离器、环行器、移相器、调制解调器；光电子元器件和组件：红外发射管、红外接收管、光电开关、光敏管、发光二极管和发光二极管组件、半导体激光二极管和激光器组件、光电探测器和光接收组件、光发射接收模块、光纤激光器和光放大器、光调制器、光开关、DWDM 用光发射和接收器件、用户接入系统光光收发器件与模块、光纤连接器、光纤跳线/尾纤、光衰减器、光纤适 配器、光隔离器、光耦合器、光环行器、光复用器/转换器；无线收发芯片和模组、蓝牙芯片和模组。

更多产品请看本公司产品专用销售网站:

商斯达中国传感器科技信息网：http://www.sensor-ic.com/

商斯达工控安防网：http://www.pc-ps.net/

商斯达电子元器件网：http://www.sunstare.com/

商斯达微波光电产品网:HTTP://www.rfoe.net/

商斯达消费电子产品网://www.icasic.com/

商斯达实业科技产品网://www.sunstars.cn/ 微波元器件销售热线：

地址：深圳市福田区福华路福庆街鸿图大厦 1602 室

电话：0755-82884100 83397033 83396822 83398585

传真：0755-83376182 （0）13823648918 MSN: SUNS8888@hotmail.com

邮编：518033 E-mail:szss20@163.com QQ: 195847376

深圳赛格展销部：深圳华强北路赛格电子市场 2583 号 电话：0755-83665529 25059422

技术支持: 0755-83394033 13501568376

欢迎索取免费详细资料、设计指南和光盘 ；产品凡多，未能尽录，欢迎来电查询。

北京分公司：北京海淀区知春路 132 号中发电子大厦 3097 号

TEL：010-81159046 82615020 13501189838 FAX：010-62543996

上海分公司：上海市北京东路 668 号上海赛格电子市场 D125 号

TEL：021-28311762 56703037 13701955389 FAX：021-56703037

西安分公司：西安高新开发区 20 所(中国电子科技集团导航技术研究所)

西安劳动南路 88 号电子商城二楼 D23 号

TEL：029-81022619 13072977981 FAX:029-88789382